

UG4D

ULTRAFAST EFFICIENT GLASS PASSIVATED RECTIFIER

VOLTAGE: 200V

CURRENT: 4.0A

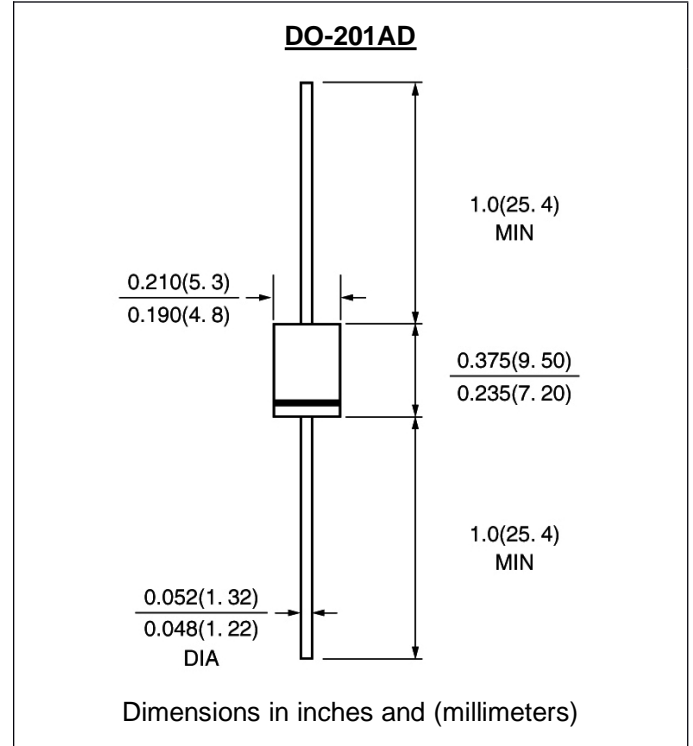


FEATURE

Low power loss
High surge capability
Glass passivated chip junction
Ultra-fast recovery time for high efficiency
High temperature soldering guaranteed
250°C/10sec/0.375" lead length at 5 lbs tension

MECHANICAL DATA

Terminal: Plated axial leads solderable per MIL-STD 202E, method 208C
Case: Molded with UL-94 Class V-0 recognized Flame Retardant Epoxy
Polarity: color band denotes cathode
Mounting position: any



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half -wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated)

	SYMBOL	UG4D	units
Maximum Recurrent Peak Reverse Voltage	V _{rrm}	200	V
Maximum RMS Voltage	V _{rms}	140	V
Maximum DC blocking Voltage	V _{dc}	200	V
Maximum Average Forward Rectified Current 3/8" lead length at Ta =50°C	I _{f(av)}	4.0	A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{fsm}	150	A
Maximum Forward Voltage at Forward current	V _f	0.95	V
Maximum DC Reverse Current at rated DC blocking voltage	I _r	5.0 250.0	μ A μ A
Maximum Reverse Recovery Time	T _{rr}	20	nS
Typical Junction Capacitance	C _j	26	pF
Typical Thermal Resistance	R _{th(ja)}	25	°C/W
Storage and Operating Junction Temperature	T _{stg} , T _j	-55 to +150	°C

Note:

1. Reverse Recovery Condition I_f =0.5A, I_r =1.0A, I_{rr} =0.25A
2. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
3. Thermal Resistance from Junction to Ambient at 3/8" lead length, P.C. Board Mounted

Fig. 1 – Forward Current Derating Curves

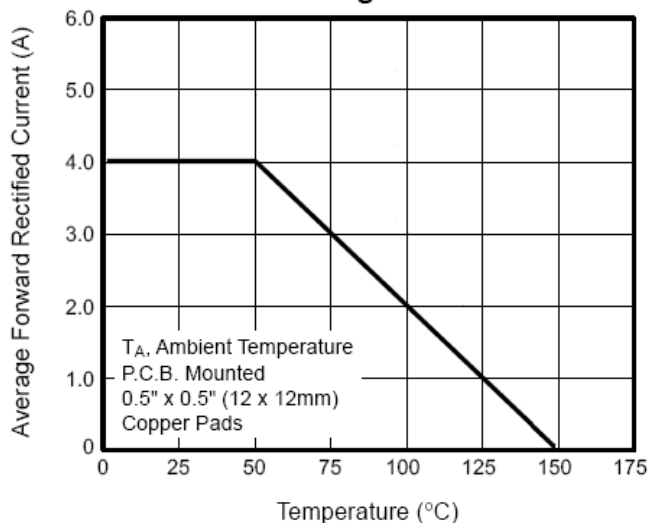


Fig. 2 – Maximum Non-Repetitive Peak Forward Surge Current

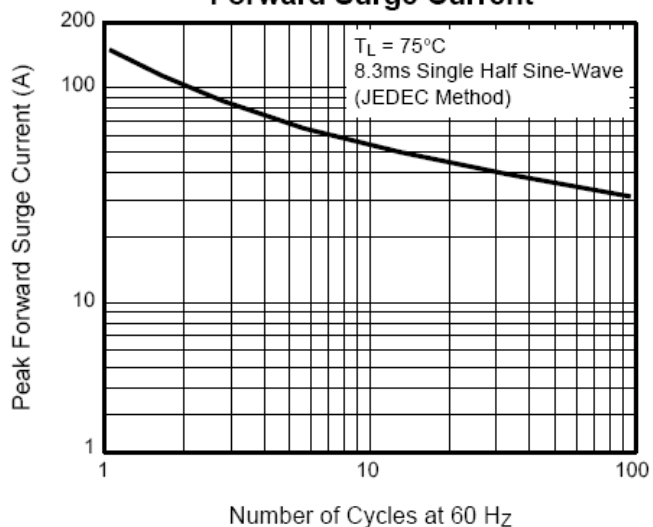


Fig. 3 – Typical Instantaneous Forward Characteristics

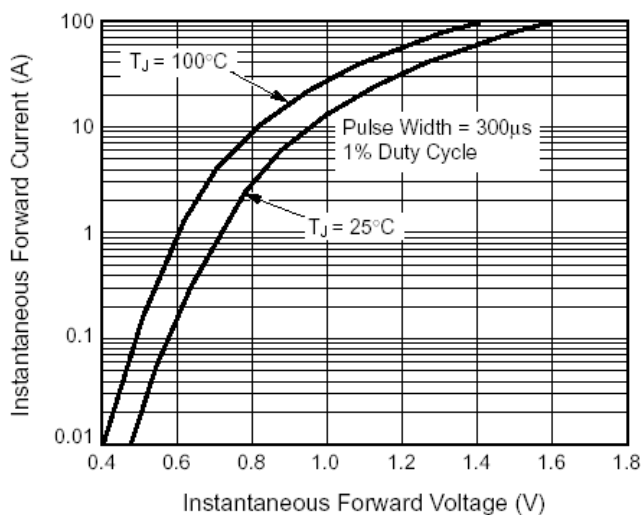


Fig. 4 – Typical Reverse Leakage Characteristics

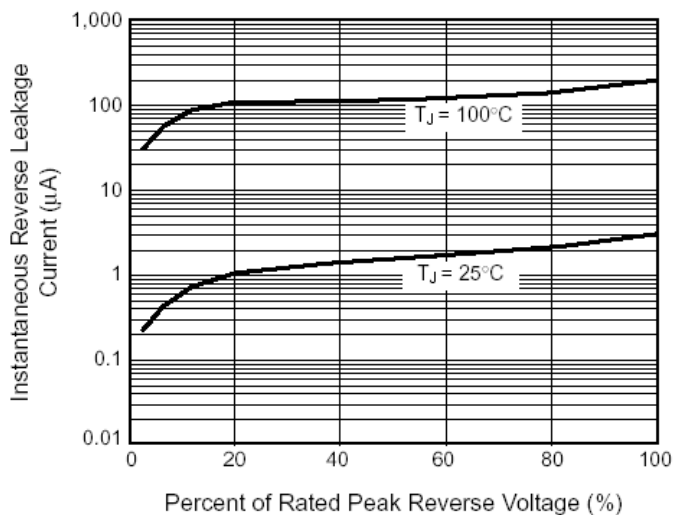


Fig. 5 – Reverse Switching Characteristics

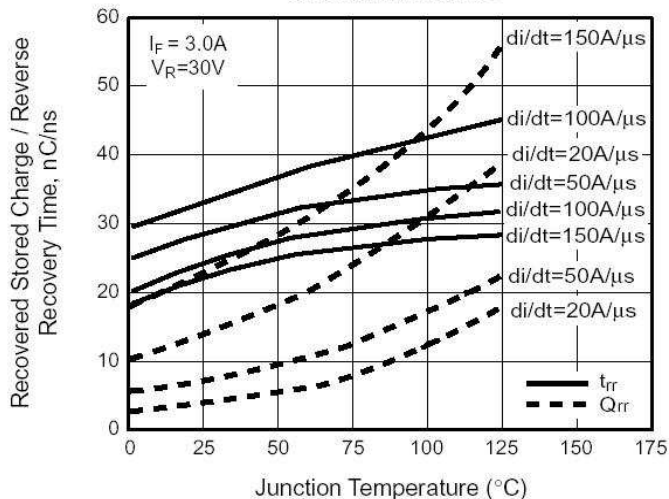


Fig. 6 – Typical Junction Capacitance

